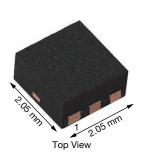


# P-Channel 30 V (D-S) MOSFET

## PowerPAK® SC-70-6L Single



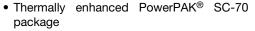


Marking code: KD

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.045				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.053				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.081				
Q <sub>g</sub> typ. (nC)	10.6				
I <sub>D</sub> (A) a, e	-9				
Configuration	Single				

#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> tested



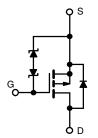
- Small footprint area
- Low on-resistance
- Typical ESD protection: 3000 V (HBM)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Power management for portable and consumer
- · Load switch
- · Charger switches
- · Battery switches



RoHS COMPLIANT HALOGEN FREE



P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA4371EDJ-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage		$V_{GS}$	± 12	v	
	T <sub>C</sub> = 25 °C		-9 e		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1 .	-9 e		
	T <sub>A</sub> =25 °C	I <sub>D</sub>	-6.4 b, c		
	T <sub>A</sub> = 70 °C		-5.1 <sup>b, c</sup>	Α	
Pulsed drain current (t = 300 μs)		I <sub>DM</sub>	-20		
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-9 e		
	T <sub>A</sub> = 25 °C	l <sub>S</sub>	-2.4 b, c		
Maximum power dissipation	T <sub>C</sub> = 25 °C	- P <sub>D</sub>	15.6		
	T <sub>C</sub> = 70 °C		10	10/	
	T <sub>A</sub> = 25 °C		2.9 b, c	W	
	T <sub>A</sub> = 70 °C		1.9 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) c, d			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R <sub>thJA</sub>	32	43	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	6	8	C/VV	

#### Notes

- a. T<sub>C</sub> = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 80 °C/W
- e. Package limited



# Vishay Siliconix

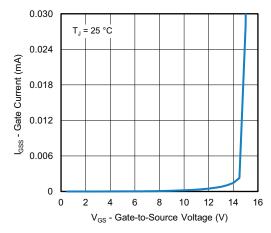
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•				
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -250 μA	-	-24	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$		-	2.2	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.6	-	-1.5	V	
Gate-source leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 10		
	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 1	μΑ	
Zero gate voltage drain current		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1		
	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
		$V_{GS} = -10 \text{ V}, I_D = -3.7 \text{ A}$	-	0.034	0.045	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -2 \text{ A}$	-	0.041	0.053		
	, ,	$V_{DS} = -2.5 \text{ V}, I_{D} = -2 \text{ A}$	-	0.068	0.081		
Dynamic <sup>b</sup>			•		•		
Total coto alcono	0	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -3.7 \text{ A}$	-	22.8	35		
Total gate charge	$Q_g$		-	10.6	16		
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -15 V, $V_{GS}$ = -4.5 V, $I_D$ = -3.7 A	-	1.7	-	nC -	
Gate-drain charge	Q <sub>qd</sub>		-	2.6	-		
Gate resistance	$R_{g}$	f = 1 MHz	2.2	11	22	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	28	42		
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_L = 5.2 \Omega, I_D \cong -2.9 \text{ A},$	-	65	98		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	47	71	1	
Fall time	t <sub>f</sub>		-	62	93	1	
Turn-on delay time	t <sub>d(on)</sub>		-	7	14	ns	
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \ R_L = 5.2 \ \Omega, \ I_D \cong -2.9 \ A,$ $V_{GEN} = -10 \text{ V}, \ R_g = 1 \ \Omega$	-	8	16	= - -	
Turn-off delay time	t <sub>d(off)</sub>		-	52	78		
Fall time	t <sub>f</sub>		-	52	78		
<b>Drain-Source Body Diode Characterist</b>	ics		•				
Continuous source-drain diode current	IS	T <sub>C</sub> = 25 °C -	-	-1.4			
Pulse diode forward current	I <sub>SM</sub>		-	-	-20	A	
Body diode voltage	$V_{SD}$	$I_{S} = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	13	20	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -2.9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	6	12	nC	
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	9	-		
Reverse recovery rise time	t <sub>b</sub>		_	4	_	ns	

#### **Notes**

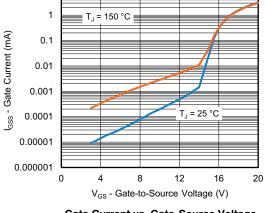
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



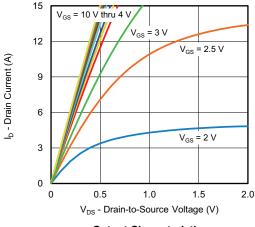


Gate Current vs. Gate-Source Voltage

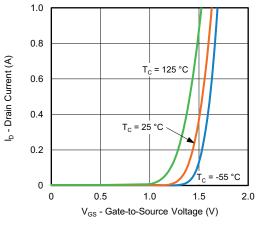


10

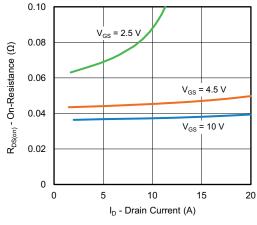
Gate Current vs. Gate-Source Voltage



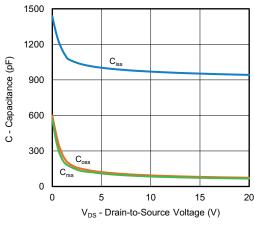
**Output Characteristics** 



**Transfer Characteristics** 

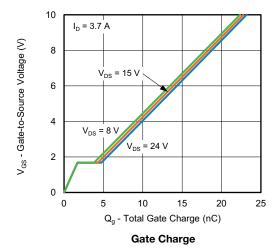


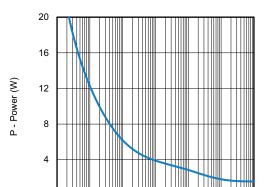
On-Resistance vs. Drain Current



Capacitance







0.01

0.001

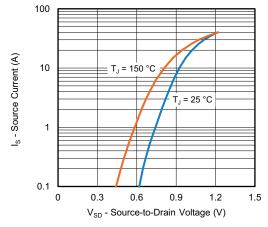
0.1

t - Time (s) Single Pulse Power, Junction-to-Ambient

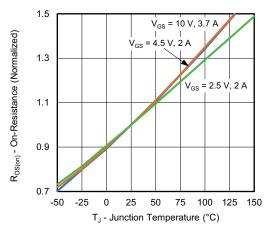
10

100

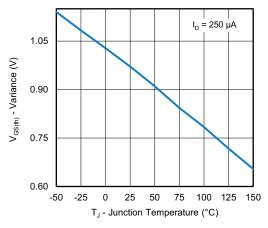
1000



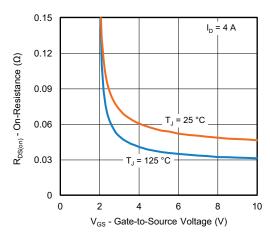
Source-Drain Diode Forward Voltage



On-Resistance vs. Junction Temperature

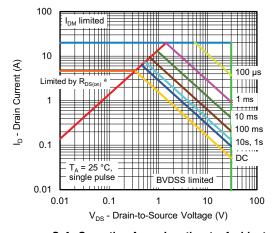


Threshold Voltage

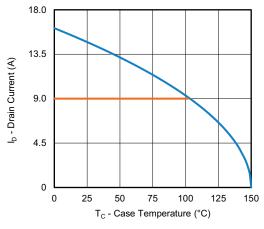


On-Resistance vs. Gate-to-Source Voltage

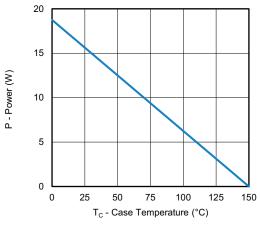


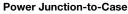


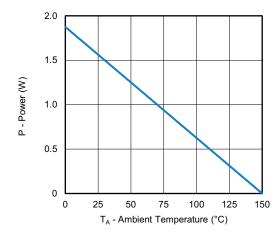
Safe Operating Area, Junction-to-Ambient



Current Derating a





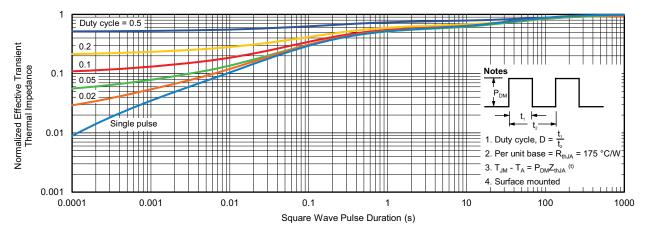


**Power Junction-to-Ambient** 

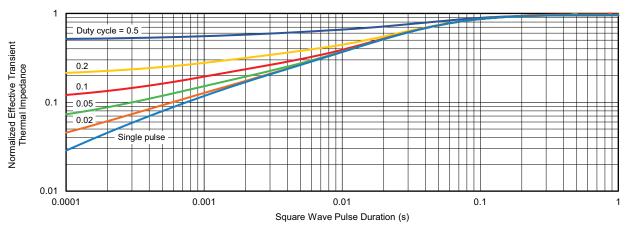
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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